



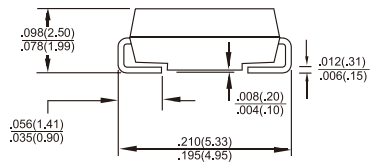
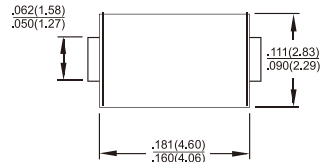
S2AA - S2MA

1.5 AMPS. Surface Mount Rectifiers

SMA/DO-214AC

Features

- ✧ UL Recognized File # E-326243
- ✧ For surface mounted application
- ✧ Glass passivated junction chip.
- ✧ Low forward voltage drop
- ✧ High current capability
- ✧ Easy pick and place
- ✧ High surge current capability
- ✧ Plastic material used carries Underwriters Laboratory Classification 94V-0
- ✧ High temperature soldering: 260°C / 10 seconds at terminals
- ✧ Green compound with suffix "G" on packing code & prefix "G" on datecode.



Dimensions in inches and (millimeters)

Marking Diagram



S2XA = Specific Device Code
 G = Green Compound
 Y = Year
 M = Work Month

Mechanical Data

- ✧ Case: Molded plastic
- ✧ Terminals: Pure tin plated, lead free.
- ✧ Polarity: Indicated by cathode band
- ✧ Packaging: 12mm tape per EIA STD RS-481
- ✧ Weight: 0.064 grams

Maximum Ratings and Electrical Characteristics

Rating at 25°C ambient temperature unless otherwise specified.

Single phase, half wave, 60 Hz, resistive or inductive load.

For capacitive load, derate current by 20%

| Type Number | Symbol | S2 AA | S2 BA | S2 DA | S2 GA | S2 JA | S2 KA | S2 MA | Units |
|---|--------------------------------------|-------------|-------|-------|-------|-------|-------|-------|-------|
| Maximum Recurrent Peak Reverse Voltage | V _{RRM} | 50 | 100 | 200 | 400 | 600 | 800 | 1000 | V |
| Maximum RMS Voltage | V _{RMS} | 35 | 70 | 140 | 280 | 420 | 560 | 700 | V |
| Maximum DC Blocking Voltage | V _{DC} | 50 | 100 | 200 | 400 | 600 | 800 | 1000 | V |
| Maximum Average Forward Rectified Current @ T _L = 100°C | I _{F(AV)} | 1.5 | | | | | | | A |
| Peak Forward Surge Current, 8.3 ms Single Half Sine-wave Superimposed on Rated Load (JEDEC method) | I _{FSM} | 50 | | | | | | | A |
| Maximum Instantaneous Forward Voltage @ 1.5A | V _F | 1.1 | | | | | | | V |
| Maximum DC Reverse Current at Rated DC Blocking Voltage @ T _A = 25°C (Note 1) | I _R | 5.0 | | | | | | | uA |
| | | 125 | | | | | | | uA |
| Typical Reverse Recovery Time (Note 4) | T _{rr} | 1.5 | | | | | | | uS |
| Typical Junction Capacitance (Note 2) | C _j | 30 | | | | | | | pF |
| Typical Thermal resistance (Note 3) | R _{θJL} R _{θJA} | 16 53 | | | | | | | °C/W |
| Operating Temperature Range | T _J | -55 to +150 | | | | | | | °C |
| Storage Temperature Range | T _{STG} | -55 to +150 | | | | | | | °C |

- Notes: 1. Pulse Test with PW=300 usec, 1% Duty Cycle
 2. Measured at 1 MHz and Applied V_R=4.0 Volts
 3. Measured on P.C. Board with 0.2" x 0.2" (5.0 mm x 5.0mm) Copper Pad Areas.
 4. Reverse Recovery Test Conditions: I_F=0.5A, I_R=1.0A, I_{RR}=0.25A

RATINGS AND CHARACTERISTIC CURVES (S2AA THRU S2MA)

FIG.1- MAXIMUM FORWARD CURRENT DERATING CURVE

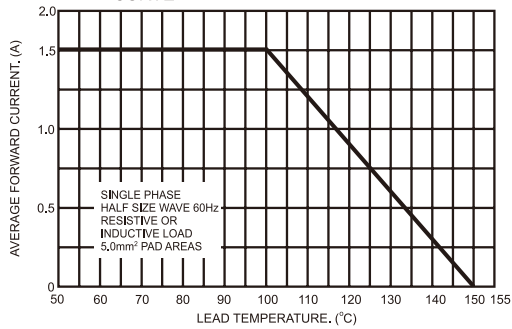


FIG.2- TYPICAL REVERSE CHARACTERISTICS

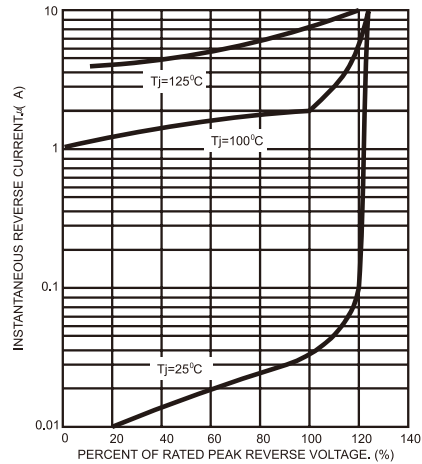


FIG.3- MAXIMUM NON-REPETITIVE FORWARD SURGE CURRENT

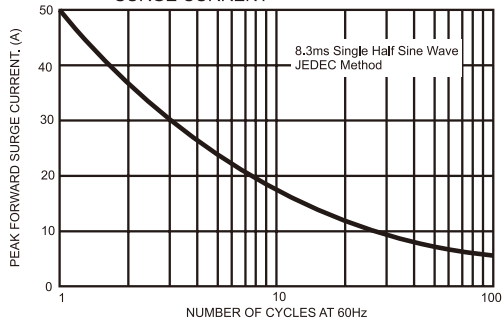


FIG.5- TYPICAL FORWARD CHARACTERISTICS

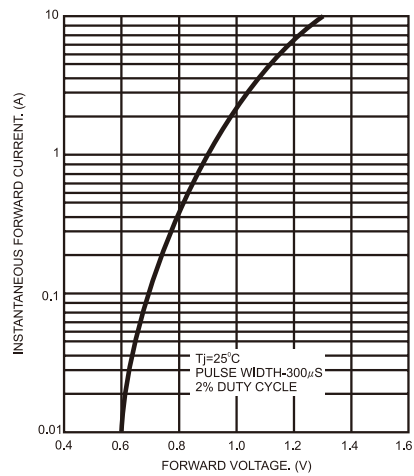


FIG.4- TYPICAL JUNCTION CAPACITANCE

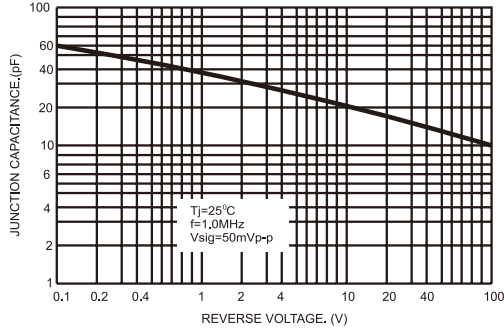


FIG.6- REVERSE RECOVERY TIME CHARACTERISTIC AND TEST CIRCUIT DIAGRAM

